Clock Generator for PowerQUICC III

MPC9855

The MPC9855 is a PLL based clock generator specifically designed for Freescale Microprocessor and Microcontroller applications including the PowerPC and PowerQUICC. This device generates a microprocessor input clock. The microprocessor clock is selectable in output frequency to any of the commonly used microprocessor input and bus frequencies. The device offers eight low skew clock outputs in two banks, each configurable to support different clock frequencies. The extended temperature range of the MPC9855 supports telecommunication and networking requirements.

MICROPROCESSOR CLOCK GENERATOR

VF SUFFIX
VM SUFFIX (PB-FREE)
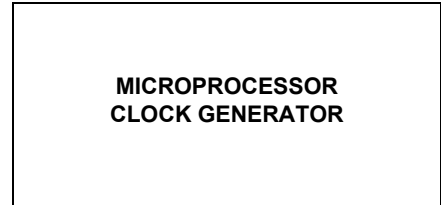**100 MAPBGA PACKAGE**
CASE 1462-01

Features

- 8 LVCMOS outputs for processor and other circuitry
- Crystal oscillator or external reference input
- 25 or 33 MHz Input reference frequency
- Selectable output frequencies include = 200, 166, 133,125, 111, 100, 83, 66, 50, 33, or 16 MHz
- Buffered reference clock output (2 copies)
- Low cycle-to-cycle and period jitter
- 100-lead PBGA package
- 100-lead Pb-free Package Available
- 3.3 V supply with 3.3 V or 2.5 V LVCMOS output supplies
- Supports computing, networking, telecommunications applications
- Ambient temperature range –40°C to +85°C

Functional Description

The MPC9855 uses either a 25 or 33 MHz reference frequency to generate 8 LVCMOS output clocks, of which, the frequency is selectable from 16 MHz to 200 MHz. The reference is applied to the input of a PLL and multiplied to 2 GHz. Output dividers, divide this frequency by 10, 12, 15, 16, 18, 20, 24, 30, 40, 60, or 120 to produce output frequencies of 200, 166, 133, 125, 111, 100, 83, 66, 50, 33, or 16 MHz. The single-ended LVCMOS outputs provide 8 low skew outputs for use in driving a microprocessor or microcontroller clock input as well as other system components. The input reference, either crystal or external input is also buffered to a separate dual outputs that my be used as the clock source for a Ethernet PHY if desired.

The reference clock may be provided by either an external clock input of 25 or 33 MHz. An internal oscillator requiring a 25 MHz crystal for frequency control may also be used. The external clock source my be applied to either of two clock inputs and selected via the CLK_SEL control input. Both single ended LVCMOS and differential LVPECL inputs are available. The crystal oscillator or external clock input is selected via the input pin of XTAL_SEL. Other than the crystal, no external components are required for crystal oscillator operation. The REF_33 MHz configuration pin is used to select between a 33 and 25 MHz input frequency.

The MPC9855 is packaged in a 100 lead MAPBGA package to optimize both performance and board density.
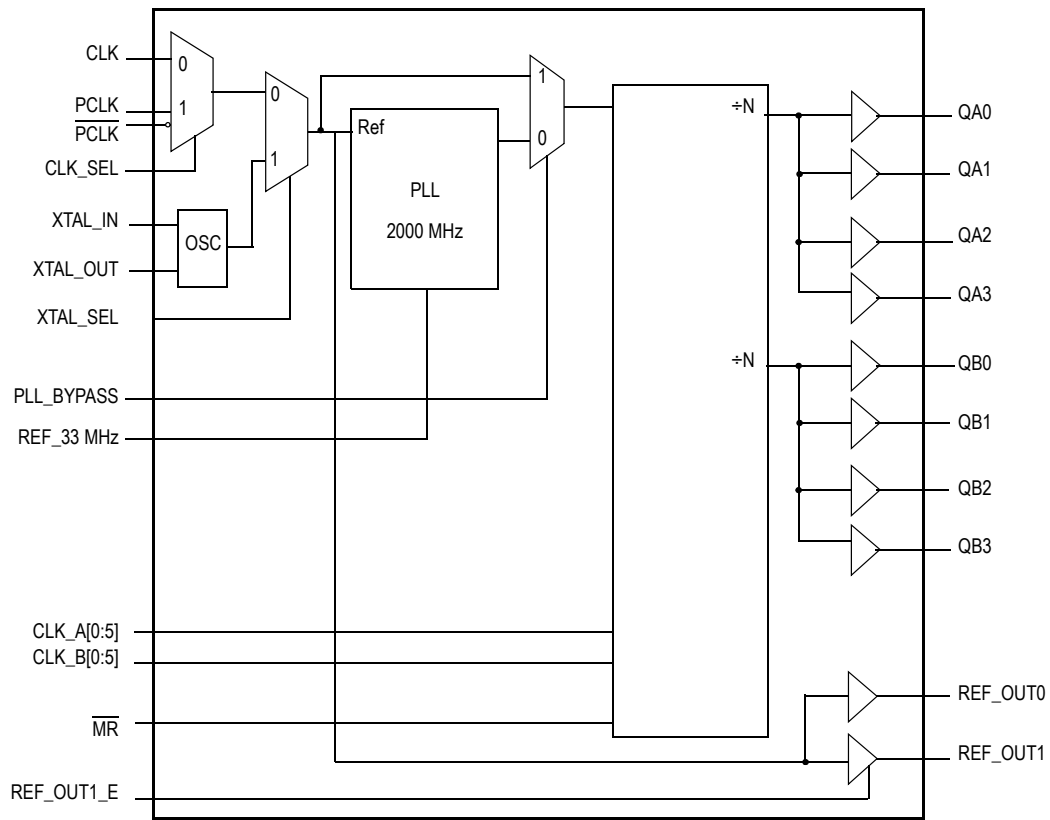
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Figure 1. MPC9855 Logic Diagram

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Table 1. Pin Configurations

Pin	I/O	Type	Function	Supply	Active/State
CLK	Input	LVCMOS	PLL Reference Clock Input (pull-down)	V_{DD}	
PCLK, $\overline{PCLK}$	Input	LVPECL	PLL reference clock input (PCLK — pull-down, $\overline{PCLK}$ — pull-up and pull-down)	V_{DD}	—
QA0, QA1, QA2, QA3	Output	LVCMOS	Clock Outputs	V_{DDOA}	—
QB0, QB1, QB2, QB3	Output	LVCMOS	Clock Outputs	V_{DDOB}	—
REF_OUT0 REF_OUT1	Output	LVCMOS	Reference Output (25 MHz or 33 MHz)	V_{DD}	—
XTAL_IN	Input	LVCMOS	Crystal Oscillator Input Pin	V_{DD}	—
XTAL_OUT	Output	LVCMOS	Crystal Oscillator Output Pin	V_{DD}	—
CLK_SEL	Input	LVCMOS	Select between CLK and PCLK input (pull-down)	V_{DD}	High
XTAL_SEL	Input	LVCMOS	Select between External Input and Crystal Oscillator Input (pull-down)	V_{DD}	High
REF_33 MHz	Input	LVCMOS	Selects 33MHz input (pull-down)	V_{DD}	High
REF_OUT1_E	Input	LVCMOS	Enables REF_OUT1 output (pull-down)	V_{DD}	High
$\overline{MR}$	Input	LVCMOS	Master Reset (pull-up)	V_{DD}	Low
PLL_BYPASS	Input	LVCMOS	Select PLL or static test mode (pull-down)	V_{DD}	High
CLK_A[0:5][1]	Input	LVCMOS	Configures Bank A clock output frequency (pull-up)	V_{DD}	—
CLK_B[0:5][2]	Input	LVCMOS	Configures Bank B clock output frequency (pull-up)	V_{DD}	—
V_{DD}	—	—	3.3 V Supply	—	—
V_{DDA}	—	—	Analog Supply	—	—
V_{DDOA}	—	—	Output Supply — Bank A	—	—
V_{DDOB}	—	—	Output Supply — Bank B	—	—
GND	—	—	Ground	—	—

1. PowerPC bit ordering (bit 0 = msb, bit 5 = lsb)
2. PowerPC bit ordering (bit 0 = msb, bit 5 = lsb)

Table 2. Function Table

Control	Default	0	1
CLK_SEL	0	CLK	PCLK
XTAL_SEL	0	CLKx	XTAL
PLL_BYPASS	0	Normal	Bypass
REF_OUT1_E	0	Disables REF_OUT1	Enables REF_OUT1
REF_33 MHz	0	Selects 25 MHz Reference	Selects 33 MHz Reference
$\overline{MR}$	1	Reset	Normal

CLK_A and CLK_B control output frequencies. See Table 3 for specific device configuration

Table 3. Output Configurations (Banks A & B)

CLK_x[0:5][1]	CLK_x[0] (msb)	CLK_x[1]	CLK_x[2]	CLK_x[3]	CLK_x[4]	CLK_x[5] (lsb)	N	Frequency (MHz)
111111	1	1	1	1	1	1	126	15.87
111100	1	1	1	1	0	0	120	16.67
101000	1	0	1	0	0	0	80	25.00
011110	0	1	1	1	1	0	60	33.33
010100	0	1	0	1	0	0	40	50.00
001111	0	0	1	1	1	1	30	66.67
001100	0	0	1	1	0	0	24	83.33
001010	0	0	1	0	1	0	20	100.00
001001	0	0	1	0	0	1	18	111.11
001000	0	0	1	0	0	0	16	125.00
000111	0	0	0	1	1	1	15	133.33
000110	0	0	0	1	1	0	12	166.67
000101	0	0	0	1	0	1	10	200.00
000100	0	0	0	1	0	0	8[2]	250

1. PowerPC bit ordering (bit 0 = msb, bit 5 = lsb)
2. Minimum value for N

OPERATION INFORMATION

Output Frequency Configuration

The MPC9855 was designed to provide the commonly used frequencies in PowerQUICC, PowerPC and other microprocessor systems. **Table 3** lists the configuration values that will generate those common frequencies. The MPC9855 can generate numerous other frequencies that may be useful in specific applications. The output frequency (f_{out}) of either Bank A or Bank B may be calculated by the following equation.

$$f_{out} = 2000 / N$$

where f_{out} is in MHz and $N = 2 * CLK\_x[0:5]$

This calculation is valid for all values of N from 8 to 126. Note that N = 15 is a modified case of the configuration inputs CLK_x[0:5]. To achieve N = 15 CLK_x[0:5] is configured to 00111 or 7.

Crystal Input Operation

TBD

Power-Up and $\overline{MR}$ Operation

Figure 2 defines the release time and the minimum pulse length for $\overline{MR}$ pin. The $\overline{MR}$ release time is based upon the power supply being stable and within V_{DD} specifications. See **Table 9** for actual parameter values. The MPC9855 may be configured after release of reset and the outputs will be stable for use after lock is obtained.
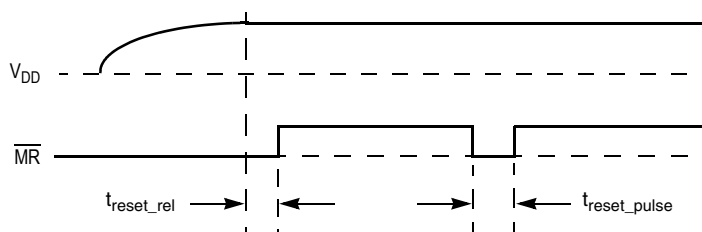

Figure 2. MR Operation

Power Supply Bypassing

The MPC9855 is a mixed analog/digital product. The architecture of the MPC9855 supports low noise signal operation at high frequencies. In order to maintain its superior signal quality, all V_{DD} pins should be bypassed by high-frequency ceramic capacitors connected to GND. If the spectral frequencies of the internally generated switching noise on the supply pins cross the series resonant point of an individual bypass capacitor, its overall impedance begins to look inductive and thus increases with increasing frequency. The parallel capacitor combination shown ensures that a low impedance path to ground exists for frequencies well above the noise bandwidth.
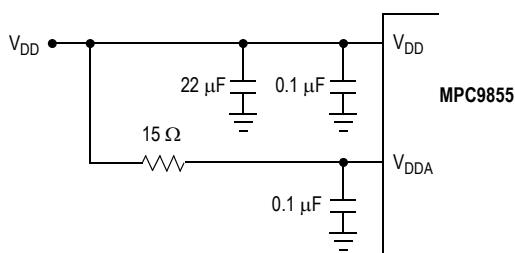

Figure 3. V$_{CC}$ Power Supply Bypass

Power Consumption Calculation

For unloaded outputs the power consumption of the MPC9855 can be calculated as follows.

$$P = V_{DD} * I_{DDBASE} + n_A * (V_{DDOA} ** 2 * C_{PD} * f_A)$$
$$+ n_B * (V_{DDOB} ** 2 * C_{PD} * f_B)$$

where
  V_{DD} = core supply voltage
  I_{DDBASE} = base supply current
  n_A = number of A bank outputs (= 4)
  n_B = number of B bank outputs (= 4)
  V_{DDOA} = voltage supply on bank A outputs
  V_{DDOB} = voltage supply on bank B outputs
  C_{PD} = power dissipation capacitance
  f_A = frequency of bank A outputs
  f_B = frequency of bank B outputs

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Table 4. Absolute Maximum Ratings[1]

Symbol	Characteristics	Min	Max	Unit	Condition
V_{DD}	Supply Voltage (core)	−0.3	3.8	V	
V_{DDA}	Supply Voltage (Analog Supply Voltage)	−0.3	V_{DD}	V	
V_{DDOx}	Supply Voltage (LVCMOS output for Bank A and B)	−0.3	V_{DD}	V	
V_{IN}	DC Input Voltage	−0.3	V_{DD}+0.3	V	
V_{OUT}	DC Output Voltage[2]	−0.3	V_{DDx}+0.3	V	
I_{IN}	DC Input Current		±20	mA	
I_{OUT}	DC Output Current		±50	mA	
T_S	Storage Temperature	−65	125	°C	

1. Absolute maximum continuous ratings are those maximum values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation at absolute-maximum-rated conditions is not implied.
2. V_{DDx} references power supply pin associated with specific output pin.

Table 5. General Specifications

Symbol	Characteristics	Min	Typ	Max	Unit	Condition
V_{TT}	Output Termination Voltage		$V_{DD} \div 2$		V	
HBM	ESD Protection (Human Body Model)	2000			V	
CDM	ESD Protection (Charged Device Model)	500			V	
LU	Latch-Up Immunity	100			mA	
C_{IN}	Input Capacitance		4		pF	Inputs
C_{PD}	Power Dissipation Capacitance		8		pF	Per Output
θ_{JA}	Thermal Resistance (junction-to-ambient)		54.5		°C/W	Air flow = 0
T_A	Ambient Temperature	−40		85	°C	

Table 6. DC Characteristics (T_A = −40°C to 85°C)

Symbol	Characteristics	Min	Typ	Max	Unit	Condition
Supply Current for V_{DD} = 3.3 V ± 5%						
I_{DDBASE}	Base Supply Current (Core)		135	170	mA	V_{DD} + V_{DDA} pins, outputs unloaded
I_{DDA}	Maximum Supply Current (Analog Supply)			15	mA	V_{DDIN} pins

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Table 7. LVPECL DC Characteristics (T_A = –40°C to 85°C)[1]

Symbol	Characteristics	Min	Typ	Max	Unit	Condition
Differential LVPECL Clock Inputs (CLK1, $\overline{CLK1}$) for V_{DD} = 3.3 V ± 0.5%						
V_{PP}	Differential Voltage[2] (peak-to-peak) (LVPECL)	250			mV	
V_{CMR}	Differential Input Crosspoint Voltage[3] (LVPECL)	1.0		V_{DD} – 0.6	V	

1. AC characteristics are design targets and pending characterization.
2. V_{PP} is the minimum differential input voltage swing required to maintain AC characteristics including t_{PD} and device-to-device skew.
3. V_{CMR} (AC) is the crosspoint of the differential input signal. Normal AC operation is obtained when the crosspoint is within the V_{CMR} (AC) range and the input swing lies within the V_{PP} (AC) specification. Violation of V_{CMR} (AC) or V_{PP} (AC) impacts the device propagation delay, device and part-to-part skew.

Table 8. LVCMOS I/O DC Characteristics (T_A = –40°C to 85°C)

Symbol	Characteristics	Min	Typ	Max	Unit	Condition
LVCMOS for V_{DD} = 3.3 V ± 5%						
V_{IH}	Input High Voltage	2.0		V_{DD} + 0.3	V	LVCMOS
V_{IL}	Input Low Voltage			0.8	V	LVCMOS
I_{IN}	Input Current[1]			± 200	μA	V_{IN} = V_{DDL} or GND
LVCMOS for V_{DD} = 3.3 V ± 5%, V_{DDOA} = 3.3 V ± 5 and V_{DDOB} = 3.3 V ± 5%						
V_{OH}	Output High Voltage	2.4			V	I_{OH} = –24 mA
V_{OL}	Output Low Voltage			0.5	V	I_{OL} = 24 mA
Z_{OUT}	Output Impedance		14 – 17		Ω	
LVCMOS for V_{DD}= 3.3 V ± 5%, V_{DDOA} = 2.5 V ± 5% and V_{DDOB}= 2.5 V ± 5%						
V_{OH}	Output High Voltage	1.9			V	I_{OH} = –15 mA
V_{OL}	Output Low Voltage			0.4	V	I_{OL} = 15 mA
Z_{OUT}	Output Impedance		18 – 22		Ω	

1. Inputs have pull-down resistors affecting the input current.

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Table 9. AC Characteristics (V_{DD} = 3.3 V ± 5%, V_{DDOAB} = 3.3 V ± 5%, T_A= –40°C to +85°C)[1] [2]

Symbol	Characteristics		Min	Typ	Max	Unit	Condition
Input and Output Timing Specification							
f_{ref}	Input Reference Frequency (25 MHz input) Input Reference Frequency (33 MHz input) XTAL Input Input Reference Frequency in PLL Bypass Mode[3]			25 33 25	250	MHz MHz MHz MHz	PLL bypass
f_{VCO}	VCO Frequency Range[4]			2000		MHz	
f_{MCX}	Output Frequency	Bank A output Bank B output	15.87 15.87		200 200	MHz MHz	PLL locked
f_{refPW}	Reference Input Pulse Width		2			ns	
f_{refCcc}	Input Frequency Accuracy				100	ppm	
t_r, t_f	Output Rise/Fall Time		150		500	ps	20% to 80%
DC	Output Duty Cycle		43	50	57	%	Bank A and B
PLL Specifications							
t_{LOCK}	Maximum PLL Lock Time				10	ms	
t_{reset_ref}	MR Hold Time on Power Up		10			ns	
t_{reset_pulse}	MR Hold Time		10			ns	
Skew and Jitter Specifications							
$t_{sk(O)}$	Output-to-Output Skew (within a bank)				50	ps	
$t_{sk(O)}$	Output-to-Output Skew (across banks A and B)				400	ps	V_{DDOA} = 3.3 V V_{DDOB} = 3.3 V
$t_{JIT(CC)}$	Cycle-to-Cycle Jitter				200	ps	Bank A and B
$t_{JIT(PER)}$	Period Jitter				200	ps	Bank A and B
$t_{JIT(\varnothing)}$	I/O Phase Jitter	RMS (1 σ)			50	ps	Bank A and B
t_r, t_f	Output Rise/Fall Time				TBD	ns	20% to 80%

1. AC characteristics are design targets and pending characterization.
2. AC characteristics apply for parallel output termination of 50Ω to V_{TT}.
3. In bypass mode, the MPC9855 divides the input reference clock.
4. The input reference frequency must match the VCO lock range divided by the total feedback divider ratio: $f_{ref} = (f_{VCO} \div M) \cdot N$.
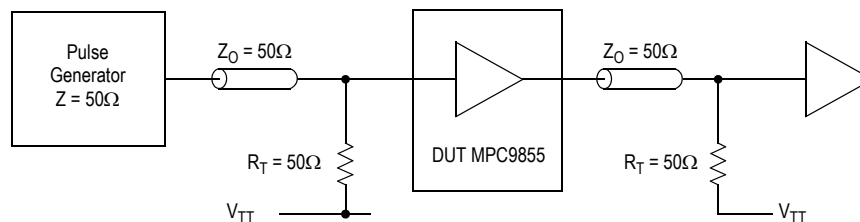

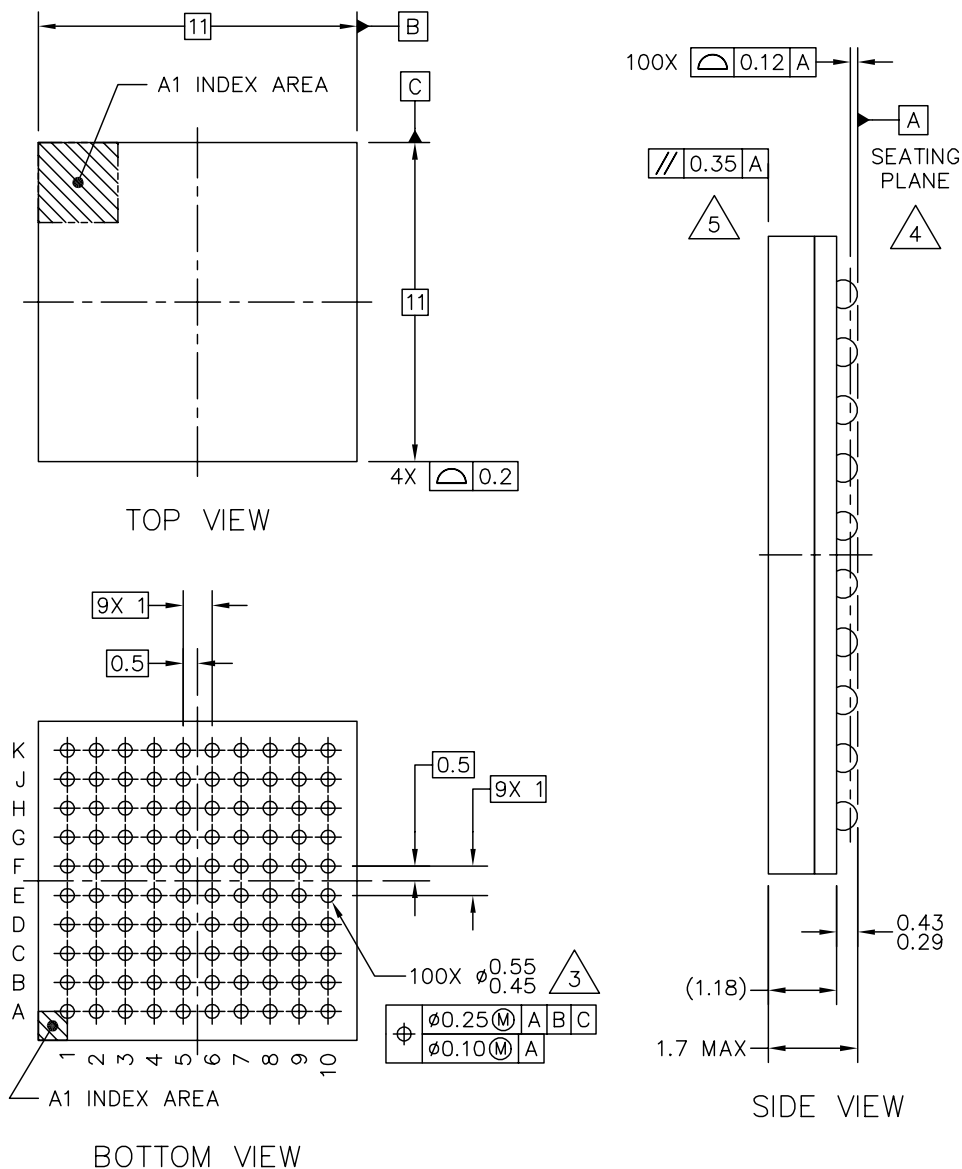**Figure 4. MPC9855 AC Test Reference (LVCMOS Outputs)**

Table 10. MPC9855 Pin Diagram (Top View)

	1	2	3	4	5	6	7	8	9	10
A	V_{DDOA}	V_{DDOA}	CLKA[1]	CLKA[3]	CLKA[5]	V_{DD}	QA1	QA2	V_{DDOA}	V_{DDOA}
B	V_{DDOA}	V_{DDOA}	CLKA[0]	CLKA[2]	CLKA[4]	QA0	V_{DDOA}	QA3	V_{DDOA}	V_{DDOA}
C	RSVD	RSVD	V_{DD}	V_{DD}	V_{DD}	V_{DD}	V_{DD}	V_{DD}	V_{DD}	REF_OUT[0]
D	V_{DDA}	V_{DDA}	V_{DD}	GND	GND	GND	GND	V_{DD}	RSVD	REF_OUT[1]
E	XTAL_SEL	CLK	V_{DD}	GND	GND	GND	GND	V_{DD}	V_{DD}	GND
F	PCLK	$\overline{PCLK}$	V_{DD}	GND	GND	GND	GND	V_{DD}	RSVD	RSVD
G	CLK_SEL	REF_33MHz	V_{DD}	GND	GND	GND	GND	V_{DD}	PLL_BYPASS	MR
H	XTAL_IN	XTAL_OUT	V_{DD}	V_{DD}	V_{DD}	V_{DD}	V_{DD}	V_{DD}	RSVD	REF_OUT1E
J	V_{DDOB}	V_{DDOB}	CLKB[0]	CLKB[2]	CLKB[4]	QB0	V_{DDOB}	QB3	V_{DDOB}	V_{DDOB}
K	V_{DDOB}	V_{DDOB}	CLKB[1]	CLKB[3]	CLKB[5]	V_{DD}	QB1	QB2	V_{DDOB}	V_{DDOB}

Table 11. MPC9855 Pin List

Signal	100 Pin MAPBGA	Signal	100 Pin MAPBGA	Signal	100 Pin MAPBGA	Signal	100 Pin MAPBGA	Signal	100 Pin MAPBGA
V_{DDOA}	A1	RSVD	C1	XTAL_SEL	E1	CLK_SEL	G1	V_{DDOB}	J1
V_{DDOA}	A2	RSVD	C2	CLK	E2	REF_33MHz	G2	V_{DDOB}	J2
CLKA[1]	A3	V_{DD}	C3	V_{DD}	E3	V_{DD}	G3	CLKB[0]	J3
CLKA[3]	A4	V_{DD}	C4	GND	E4	GND	G4	CLKB[2]	J4
CLKA[5]	A5	V_{DD}	C5	GND	E5	GND	G5	CLKB[4]	J5
V_{DD}	A6	V_{DD}	C6	GND	E6	GND	G6	QB0	J6
QA1	A7	V_{DD}	C7	GND	E7	GND	G7	V_{DDOB}	J7
QA2	A8	V_{DD}	C8	V_{DD}	E8	V_{DD}	G8	QB3	J8
V_{DDOA}	A9	V_{DD}	C9	V_{DD}	E9	PLL_BYPASS	G9	V_{DDOB}	J9
V_{DDOA}	A10	REF_OUT[0]	C10	GND	E10	$\overline{MR}$	G10	V_{DDOB}	J10
V_{DDOA}	B1	V_{DDA}	D1	PCLK	F1	XTAL_IN	H1	V_{DDOB}	K1
V_{DDOA}	B2	V_{DDA}	D2	$\overline{PCLK}$	F2	XTAL_OUT	H2	V_{DDOB}	K2
CLKA[0]	B3	V_{DD}	D3	V_{DD}	F3	V_{DD}	H3	CLKB[1]	K3
CLKA[2]	B4	GND	D4	GND	F4	V_{DD}	H4	CLKB[3]	K4
CLKA[4]	B5	GND	D5	GND	F5	V_{DD}	H5	CLKB[5]	K5
QA0	B6	GND	D6	GND	F6	V_{DD}	H6	V_{DD}	K6
V_{DDOA}	B7	GND	D7	GND	F7	V_{DD}	H7	QB1	K7
QA3	B8	V_{DD}	D8	V_{DD}	F8	V_{DD}	H8	QB2	K8
V_{DDOA}	B9	RSVD	D9	RSVD	F9	RSVD	H9	V_{DDOB}	K9
V_{DDOA}	B10	REF_OUT[1]	D10	RSVD	F10	REF_OUT1E	H10	V_{DDOB}	K10

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PACKAGE DIMENSIONS

TOP VIEW

BOTTOM VIEW

SIDE VIEW

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	STANDARD: JEDEC MO-192 DAC-1		

PAGE 1 OF 2

VA SUFFIX
VM SUFFIX (PB-FREE)
100 MAPBGA PACKAGE
CASE 1462-01
ISSUE A

PACKAGE DIMENSIONS

NOTES:

1.   ALL DIMENSIONS IN MILLIMETERS.

2.   DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.

3.   MAXIMUM SOLDER BALL DIAMETER MEASURED PARALLEL TO DATUM A.

4.   DATUM A, THE SEATING PLANE, IS DETERMINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.

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VA SUFFIX
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